

PC357NT

Mini-flat Package, General Purpose Photocoupler

■ Features

1. Opaque type, mini-flat package
PC357NT (1-channel)
2. Subminiature type
(The volume is smaller than that of our conventional DIP type by as far as 30 %.)
3. Current transfer ratio
(CTR: MIN. 50% at $I_F = 5\text{mA}$, $V_{CE} = 5\text{V}$)
4. Isolation voltage between input and output
PC357NT... $V_{iso} : 3\,750V_{rms}$
5. Recognized by UL (No. E64380)

■ Applications

1. Hybrid substrates that require high density mounting
2. Programmable controllers

■ Package Specifications

Model	Package specifications
PC357NT	Taping reel diameter 178mm (750pcs.)

■ Absolute Maximum Ratings

($T_a = 25^\circ\text{C}$)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I_F	50	mA
	*1 Peak forward current	I_{FM}	1	A
	Reverse voltage	V_R	6	V
	Power dissipation	P	70	mW
Output	Collector-emitter voltage	V_{CEO}	35	V
	Emitter-collector voltage	V_{ECO}	6	V
	Collector current	I_C	50	mA
	Collector power dissipation	P_C	150	mW
	Total power dissipation	P_{tot}	170	mW
	*2 Isolation voltage	V_{iso}	3 750	V_{rms}
	Operating temperature	T_{opr}	- 30 to + 100	$^\circ\text{C}$
	Storage temperature	T_{stg}	- 40 to + 125	$^\circ\text{C}$
	*3 Soldering temperature	T_{sol}	260	$^\circ\text{C}$

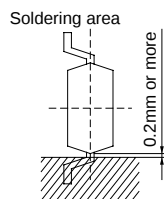
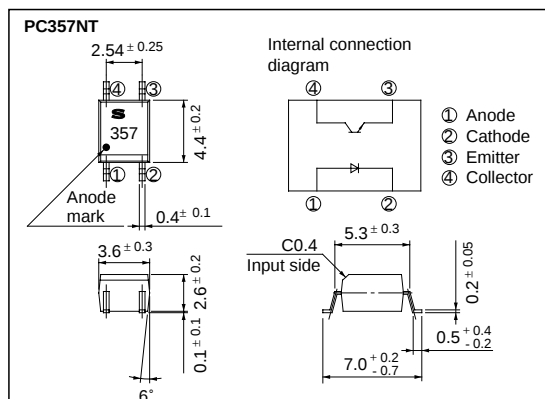
*1 Pulse width $\leq 100\mu\text{s}$, Duty ratio: 0.001

*2 40 to 60% RH, AC for 1 minute

*3 For 10 seconds

■ Outline Dimensions

(Unit : mm)



■ Electro-optical Characteristics

(Ta= 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	V _F	I _F = 20mA	-	1.2	1.4	V
	Reverse current	I _R	V _R = 4V	-	-	10	μ A
	Terminal capacitance	C _t	V = 0, f = 1kHz	-	30	250	pF
Output	Collector dark current	I _{CEO}	V _{CE} = 20V, I _F = 0	-	-	10 ⁻⁷	A
	Collector-emitter breakdown voltage	BV _{CEO}	I _C = 0.1mA, I _F = 0	35	-	-	V
	Emitter-collector breakdown voltage	BV _{ECO}	I _E = 10μ A, I _F = 0	6	-	-	V
Transfer-charac-teristics	*4 Current transfer ratio	CTR	I _F = 5mA, V _{CE} = 5V	50	-	600	%
	Collector-emitter saturation voltage	V _{CE(sat)}	I _F = 20mA, I _C = 1mA	-	-	0.2	V
	Isolation resistance	R _{ISO}	DC500V, 40 to 60% RH	5 x 10 ¹⁰	10 ¹¹	-	Ω
	Floating capacitance	C _f	V = 0, f = 1MHz	-	0.6	1.0	pF
	Response time	Rise time	V _{CE} = 2V, I _C = 2mA	-	4	18	μ s
		Fall time		-	3	18	μ s

*4 Classification table of current transfer ratio is shown below.

■ Current Transfer Ratio (CTR) Line-ups

Model No.	Rank mark	CTR (%)
PC357N1T	A	80 to 160
PC357N2T	B	130 to 260
PC357N3T	C	200 to 400
PC357N4T	D	300 to 600
PC357N5T	A or B	80 to 260
PC357N6T	B or C	130 to 400
PC357N7T	C or D	200 to 600
PC357N8T	A, B or C	80 to 400
PC357N9T	B, C or D	130 to 600
PC357N0T	A, B, C or D	80 to 600
PC357NT	A, B, C, D or No mark	50 to 600

Fig. 1 Forward Current vs. Ambient Temperature

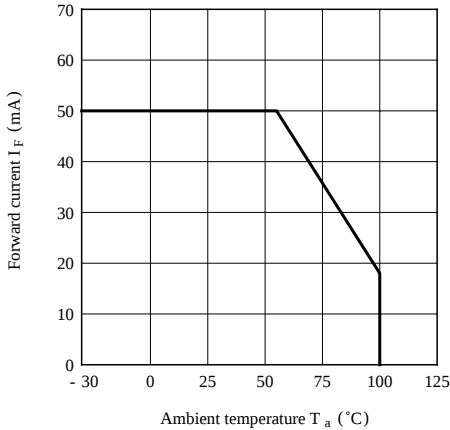


Fig. 2 Diode Power Dissipation vs. Ambient Temperature

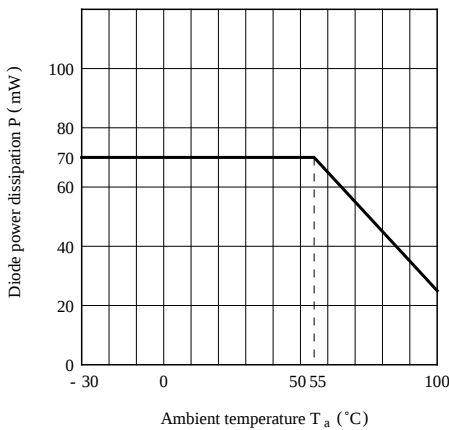


Fig. 3 Collector Power Dissipation vs. Ambient Temperature

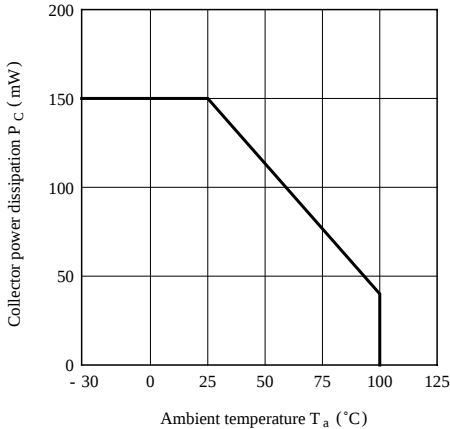


Fig. 4 Total Power Dissipation vs. Ambient Temperature

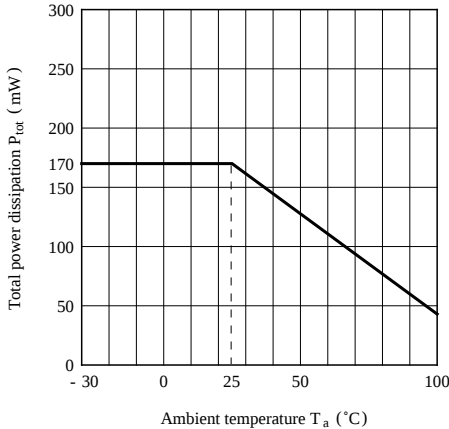


Fig. 5 Peak Forward Current vs. Duty Ratio

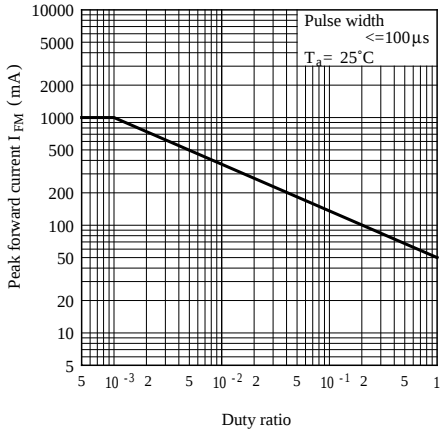


Fig. 6 Forward Current vs. Forward Voltage

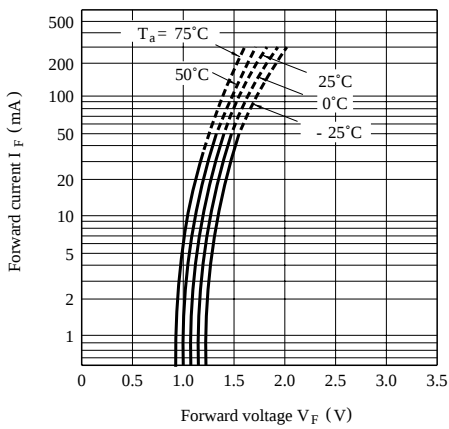


Fig. 7 Current Transfer Ratio vs. Forward Current

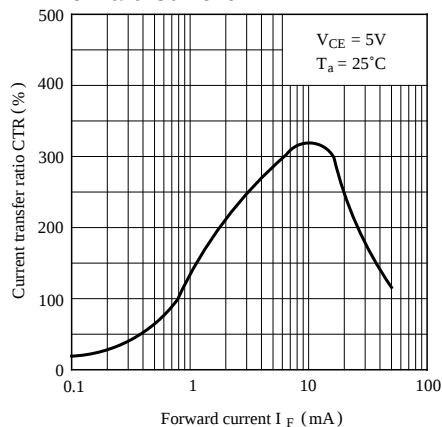


Fig. 9 Relative Current Transfer Ratio vs. Ambient Temperature

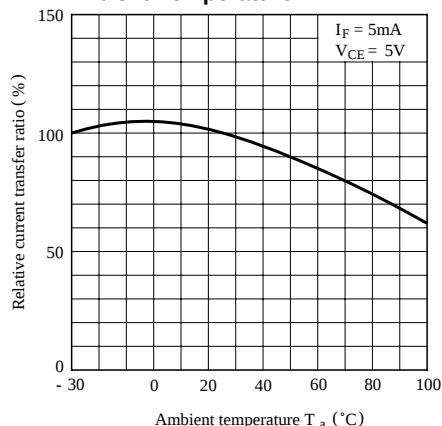


Fig.11 Collector Dark Current vs. Ambient Temperature

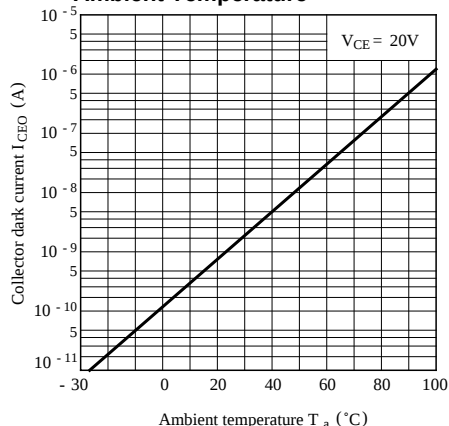


Fig. 8 Collector Current vs. Collector-emitter Voltage

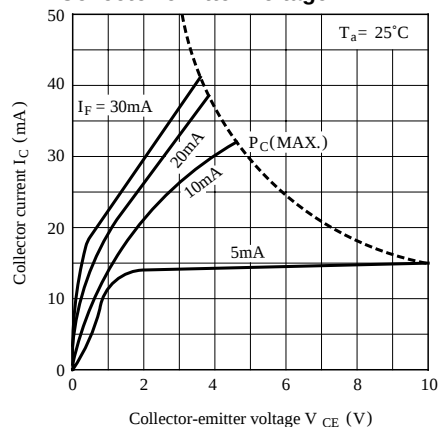


Fig.10 Collector-emitter Saturation Voltage vs. Ambient Temperature

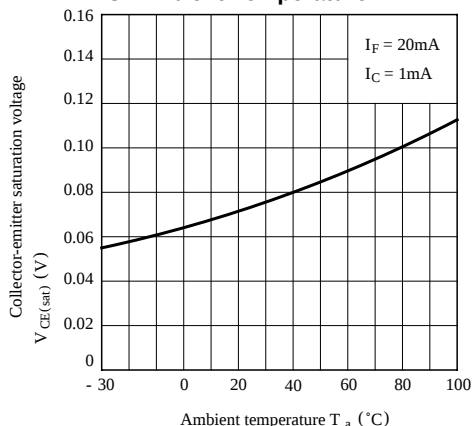
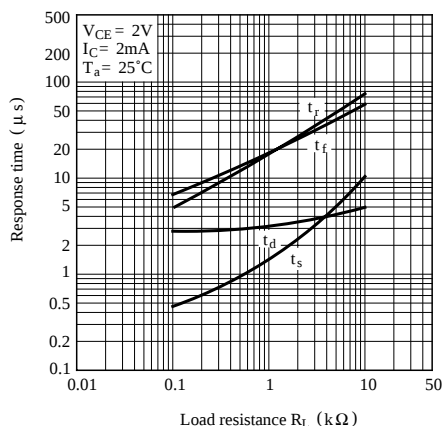


Fig.12 Response Time vs. Load Resistance



Test Circuit for Response Time

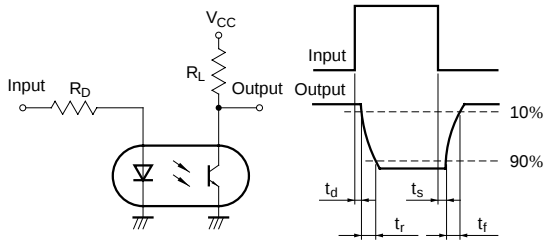
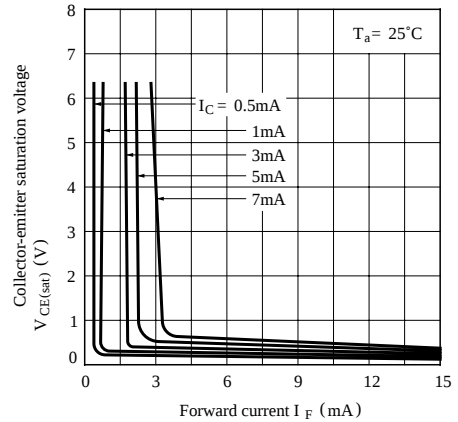
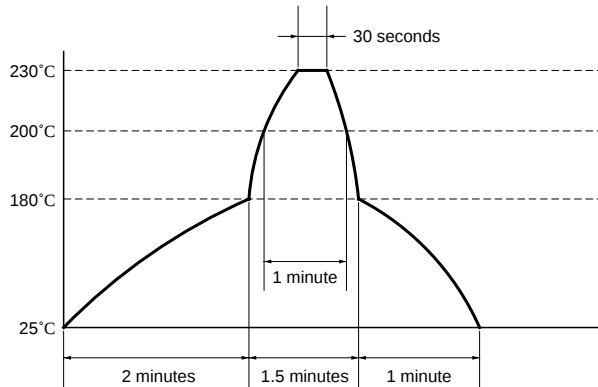


Fig.13 Collector-emitter Saturation Voltage vs. Forward Current



Temperature Profile of Soldering Reflow

- (1) One time soldering reflow is recommended within the condition of temperature and time profile shown below.



- (2) When using another soldering method such as infrared ray lamp, the temperature may rise partially in the mold of the device.
Keep the temperature on the package of the device within the condition of above (1).
- (3) As for other general cautions, refer to the chapter "Precautions for Use"